

## **KSC839**

### FM/AM RADIO RF AMP, CONV, OSC, IF AMP

• Current Gain Bandwidth Product : f<sub>T</sub>=200MHz



### 1. Emitter 2. Base 3. Collector

## **NPN Epitaxial Silicon Transistor**

## **Absolute Maximum Ratings** $T_a$ =25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CBO</sub>	Collector-Base Voltage	35	V
V <sub>CEO</sub>	Collector-Emitter Voltage	30	V
V <sub>EBO</sub>	Emitter-Base Voltage	4	V
I <sub>C</sub>	Collector Current	100	mA
P <sub>C</sub>	Collector Dissipation	250	mW
T <sub>J</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	-55 ~ 150	°C

## Electrical Characteristics T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	I <sub>C</sub> =100μA, I <sub>E</sub> =0	35			V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	$I_C=5mA$ , $I_B=0$	30			V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_E=10\mu A, I_C=0$	4			V
I <sub>CBO</sub>	Collector Cut-off Current	$V_{CB}$ =30V, $I_E$ =0			0.1	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB}$ =4V, $I_{C}$ =0			0.1	μΑ
h <sub>FE</sub>	DC Current Gain	V <sub>CE</sub> =12V, I <sub>C</sub> =2mA	40		400	
V <sub>BE</sub> (on)	Base-Emitter On Voltage	$V_{CE}=6V, I_{C}=1mA$	0.65	0.70	0.75	V
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> =10mA, I <sub>B</sub> =1mA		0.1	0.4	V
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> =10V, I <sub>C</sub> =1mA	80	200		MHz
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> =10V, I <sub>E</sub> =0, f=1MHz		2.0	3.5	pF

## **h**<sub>FE</sub> Classification

Classification	R	0	Y	G
h <sub>FE</sub>	40 ~ 80	70 ~ 140	120 ~ 240	200 ~ 400

# **Typical Characteristics**

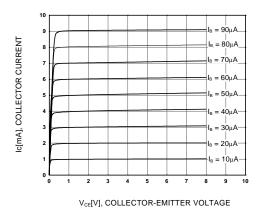


Figure 1. Static Characteristic

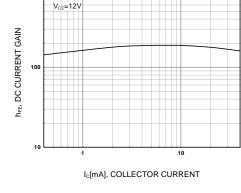


Figure 2. DC current Gain

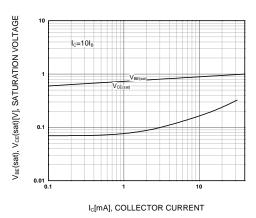


Figure 3. Base-Emitter Saturation Voltage Collector-Emitter Saturation Voltage

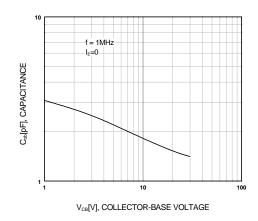


Figure 4. Collector Output Capacitance

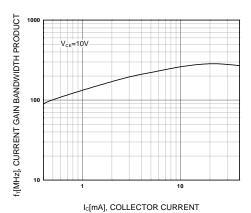
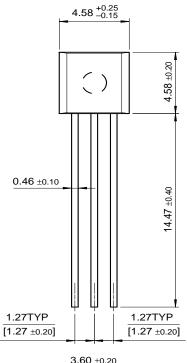


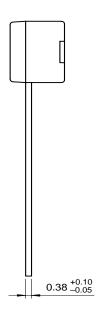
Figure 5. Current Gain Bandwidth Product

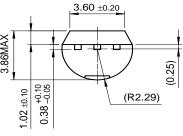
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# **Package Demensions**

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